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<u>TO:</u>	<u>Examiner Robert S. Loewe</u>	<u>FROM:</u>	<u>Christopher S. Andrzejak</u>
<u>COMPANY:</u>	<u>USPTO</u>	<u>DATE:</u>	<u>Tuesday, December 30, 2008</u>
<u>FAX NUMBER:</u>	<u>571-270-4298</u>	<u>TOTAL NUMBER OF PAGES INCLUDING COVER:</u>	<u>31</u>
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<u>CLIENT NUMBER:</u>	<u>U.S.S.N. 10/533,849 (H&H: 071051.00007)</u>	<u>SENDER'S FAX NUMBER:</u>	<u>(248) 645-1568</u>
<u>RE:</u>	<u>Statement of Accuracy of English Translation</u>		
<u>NOTES/COMMENTS:</u>			

Dear Sir,

Please find attached the translation of Japanese Patent Application No. 2002-325895 (which is the priority document for the instant application) as well as an executed Statement of Accuracy of English Translation to certify that the translation accurately reflects the disclosure in JP 2002-325895. The translation of Japanese Patent Application No. 2002-325895 is the same document that was filed with the USPTO as the original application on May 4, 2005. The Applicants respectfully submit that the translation and the Statement satisfy the Examiner's recommendations, and that, as the Examiner has recognized, PCT Publication No. WO 2002/092693 is no longer available as prior art to the instant application.

Respectfully Submitted,

Christopher S. Andrzejak
Reg. No. 57,212

Attorney docket # TSL-1803US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Hiroshi Fukui Confirmation No.: 7869
Serial No.: 10/533,849
Filed: October 24, 2005
Group Art Unit: 1796
Examiner: Loewe, Robert S.
For: HEAT CONDUCTIVE SILICONE COMPOSITION

STATEMENT OF ACCURACY OF ENGLISH TRANSLATION

Dear Sir:

This statement is to certify that I am skilled in the Japanese language and the English language, have reviewed the translation of Japanese Patent Application No. 2002-325895 included herewith, and that this translation accurately reflects the disclosure in Japanese Patent Application No. 2002-325895.



Hiromi Fujita
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